

Vishay Semiconductors

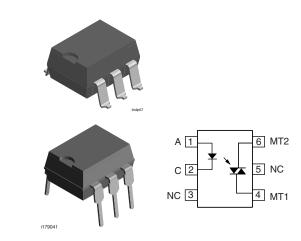
Optocoupler, Non Zero Crossing Phototriac, 1.5 kV/µs dV/dt, 600 V

RoHS

COMPLIANT

Features

- 1500 V/µs dV/dT minimum, 2000 V/µs typical
- 600 V Blocking Voltage
- Low Input Trigger Current
- 6 pin DIP package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Agency Approvals

- UL File E52744 H/J System Code
- CUL File No. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-2 (VDE0884) DIN EN 60747-5-5 pending Available with Option 1

Applications

- Household Appliances
- Triac Drive/AC Motor Drives
- Solenoid/Valve Controls
- Office Automation Equipment / Machine
- Temperature (HVAC)/Lighting Controls
- Switching Power Supply

Description

The VO3052/VO3053 triac driver family consists of a GaAs infrared LED optically coupled to a monolithic photosensitive non zero crossing triac detector chip. The 600 V blocking voltage permits control of off-line voltages up to 240 VAC, with a safety factor or more than two, and is sufficient for as much as 380 V.

Order Information

Part	Remarks
VO3053	DIP-6, NZC, 600 V, I _{ft} = 5 mA
VO3052	DIP-6, NZC, 600 V, I _{ft} = 10 mA
VO3053-X006	DIP-6 400 mil (option 6), NZC, 600 V, $I_{ft} = 5 \text{ mA}$
VO3052-X006	DIP-6 400 mil (option 6), NZC, 600 V, I_{ft} = 10 mA
VO3053-X007T	SMD-6 (option 7), NZC, 600 V, I_{ft} = 5 mA
VO3052-X007T	SMD-6 (option 7), NZC, 600 V, I _{ft} = 10 mA

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Rating for extended periods of the time can adversely affect reliability.

Input

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V _R	6.0	V
Forward current - continuous		١ _F	60	mA
Power dissipation		P _{diss}	100	mW

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Output

Parameter	Test condition	Part	Symbol	Value	Unit
Off state output terminal voltage		VO3052/3053	V _{DRM}	600	V
Peak repetitive surge current	PW = 100 ms, 120 pps		I _{TSM}	1.0	А
Power dissipation			P _{diss}	150	mW

Coupler

Parameter	Test condition	Symbol	Value	Unit
Isolation test voltage	1.0 sec	V _{ISO}	5300	V _{RMS}
Total power dissipation		P _{tot}	250	mW
Operating temperature		T _{amb}	- 40 to + 100	°C
Storage temperature		T _{stg}	- 55 to + 150	°C
Soldering temperature	10 sec	T _{sld}	260	°C

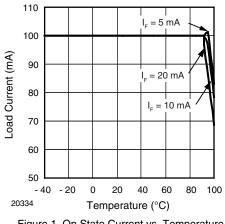


Figure 1. On State Current vs. Temperature



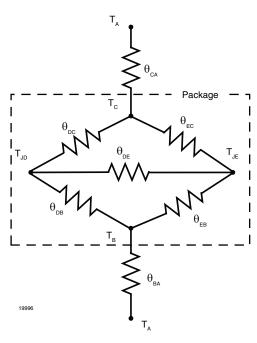


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Thermal Characteristics

The thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers Application note.

Parameter	Test condition	Symbol	Value	Unit
LED Power dissipation	at 25 °C	P _{diss}	100	mW
Output Power dissipation	at 25 °C	P _{diss}	500	mW
Total Power dissipation	at 25 °C	P _{tot}	600	mW
Maximum LED junction temperature		T _{jmax}	125	°C
Maximum output die junction temperature		T _{jmax}	125	°C
Thermal resistance, Junction Emitter to Board		θ_{JEB}	150	°C/W
Thermal resistance, Junction Emitter to Case		θ_{JEC}	139	°C/W
Thermal resistance, Junction Detector to Board		θ_{JDB}	78	°C/W
Thermal resistance, Junction Detector to Case		θ_{JDC}	109	°C/W
Thermal resistance, Junction Emitter to Junction Detector		θ_{JED}	496	°C/W
Thermal resistance, Case to Ambient		θ_{CA}	9563	°C/W



Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

Input

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Reverse current	V _R = 6 V	I _R			10	μΑ
Forward voltage	I _F = 30 mA	V _F		1.2	1.5	V

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Output

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Leakage with LED off, either direction	V _{DRM} = 600 V	I _{DRM}		10	500	nA
Critical rate of rise of off-state voltage	V _D = 400 V	dV/dt	1500	2000		V/µs

Coupler

Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
LED trigger current, current required to latch output		VO3053	I _{FT}			5	mA
		VO3052	I _{FT}			10	mA
Peak on-state voltage, either direction	I _{TM} = 100 mA Peak, I _F = Rated I _{FT}		V _{TM}		1.7	3	V
Holding current, either direction			Ι _Η		200		μA

Saftey and Insulation Ratings

As per IEC60747-5-2, §7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with safety ratings shall be ensured by means of protective circuits.

Parameter	Test condition	Symbol	Min	Тур	Max	Unit
Climatic classification	IEC 68 part 1			40/100/21		
Pollution degree	DIN VDE 0109			2		
Tracking resistance (Comparative tracking index)	Insulation group Illa	СТІ	175			
Highest allowable overvoltage	Transient overvoltage	V _{IOTM}	8000			V _{peak}
Maximum working insulation voltage	Recurring peak voltage	V _{IORM}	890			V _{peak}
Insulation resistance at 25 °C	V _{IO} = 500 V	R _{IS}			≥ 10 ¹²	Ω
Insulation resistance at T_{S}	V _{IO} = 500 V	R _{IS}			≥ 10 ¹²	Ω
Insulation resistance at 100 °C	V _{IO} = 500 V	R _{IS}			≥ 10 ¹²	Ω
Partial discharge test voltage	Method a, V _{pd} = V _{IORM} x 1.875	V _{pd}			1669	V _{peak}
Safety limiting values - Maximum values allowed in the event of a failure:						
Case temperature		T _{SI}			175	°C
Input current		I _{SI}			250	mA
Output power		P _{SO}			500	mW
Minimum external air gap (Clearance)	Measured from input terminals to output terminals, shortest distance through air		≥7			mm
Minimum external tracking (Creepage)	Measured from input terminals to output terminals, shortest distance path along body		≥7			mm
Minimum external air gap (Clearance)	Measured from input terminals to output terminals, shortest distance through air		≥8			mm
Minimum external tracking (Creepage)	Measured from input terminals to output terminals, shortest distance path along body		≥8			mm



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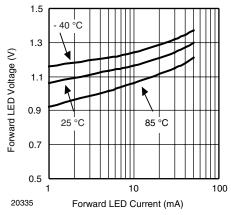


Figure 2. Forward Voltage vs. Forward Current

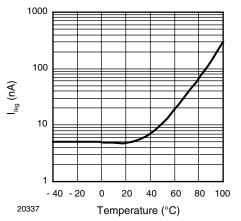
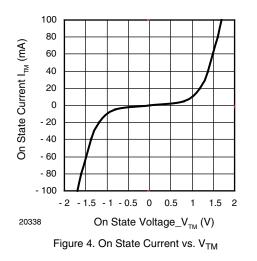
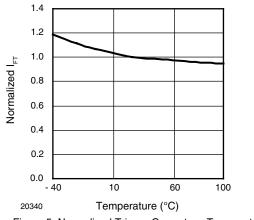


Figure 3. Off-State Leakage Current vs. Temperature







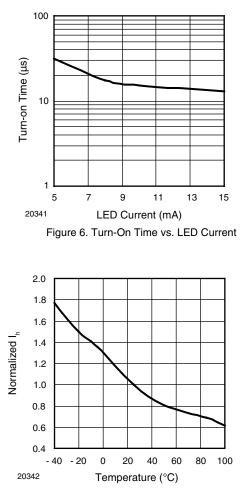
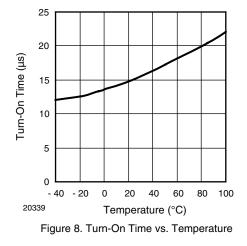
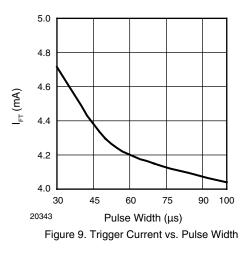


Figure 7. Normalized Holding Current vs. Temperature

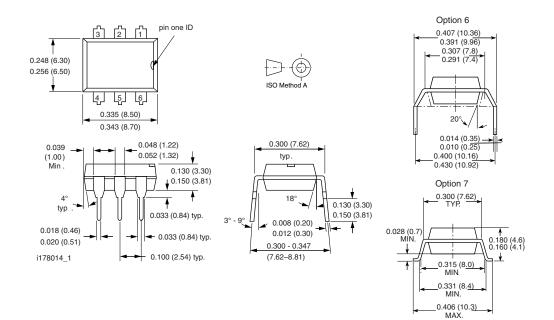
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Package Dimensions in Inches (mm)





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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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